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March 2015

Dual N & P-Channel PowerTrench[®] MOSFET N-Channel: 40V, 20A, 24m Ω P-Channel: -40V, -20A, 54m Ω

Features

Q1: N-Channel

- Max $r_{DS(on)} = 24m\Omega$ at $V_{GS} = 10V$, $I_D = 9.0A$
- Max $r_{DS(on)} = 30m\Omega$ at $V_{GS} = 4.5V$, $I_D = 7.0A$

Q2: P-Channel

- Max $r_{DS(on)} = 54m\Omega$ at $V_{GS} = -10V$, $I_D = -6.5A$
- Max $r_{DS(on)} = 70m\Omega$ at $V_{GS} = -4.5V$, $I_D = -5.6A$
- Fast switching speed
- RoHS Compliant

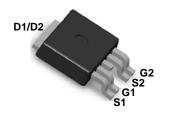


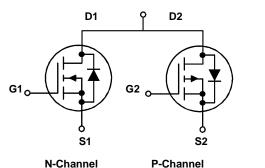
General Description

These dual N and P-Channel enhancement mode Power MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench- process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

Application

- Inverter
- H-Bridge





Dual DPAK 4L

MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units	
V _{DS}	Drain to Source Voltage		40	-40	V	
V _{GS}	Gate to Source Voltage		±20	±20	V	
	Drain Current - Continuous (Package Limited)		20	-20		
	- Continuous (Silicon Limited)	$T_C = 25^{\circ}C$	26	-20	A	
D	- Continuous	$T_A = 25^{\circ}C$	9.0	-6.5	A	
	- Pulsed		55	-40	1	
	Power Dissipation for Single Operation	$T_C = 25^{\circ}C$ (Note 1)	30	35		
PD		$T_A = 25^{\circ}C$ (Note 1a)			W	
		$T_A = 25^{\circ}C$ (Note 1b)			1	
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	29	33	mJ	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to	+150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Single Operation for Q1	(Note 1)	4.1	°C/W	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Single Operation for Q2	(Note 1)	3.5	C/VV	

Package Marking and Ordering Information

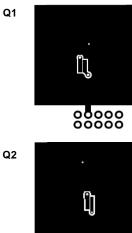
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8424H	FDD8424H	TO-252-4L	13"	16mm	2500 units

Symbol	Parameter	Test Conditions	Tuno	Min	Turn	Max	Units
		lest conditions	Туре	WIIII	Тур	Wax	Units
Off Chara	cteristics			1			
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$ $I_D = -250 \mu A, V_{GS} = 0 V$	Q1 Q2	40 -40			V
ΔΒV _{DSS} ΔΤ _J	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu A$, referenced to 25°C $I_D = -250\mu A$, referenced to 25°C	Q1 Q2		34 -32		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 32V, V_{GS} = 0V$ $V_{DS} = -32V, V_{GS} = 0V$	Q1 Q2			1 -1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	Q1 Q2			±100 ±100	nA nA
On Chara	cteristics			<u> </u>	<u> </u>		ļ
		$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	Q1	1	1.7	3	
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	Q2	-1	-1.6	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{,l}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250\mu$ A, referenced to 25°C $I_D = -250\mu$ A, referenced to 25°C	Q1 Q2		-5.3 4.8		mV/°C
		$V_{GS} = 10V, I_D = 9.0A$ $V_{GS} = 4.5V, I_D = 7.0A$	Q1		19 23	24 30	
r _{DS(on)}	Static Drain to Source On Resistance		Q2		29 42 58 62	37 54 70 80	- mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = 5V, I_D = 9.0A$ $V_{DS} = -5V, I_D = -6.5A$	Q1 Q2		29 13		S
Dynamic	Characteristics						
C _{iss}	Input Capacitance	Q1 V _{DS} = 20V, V _{GS} = 0V, f = 1MHZ	Q1 Q2		750 1000	1000 1330	pF
C _{oss}	Output Capacitance	Q2	Q1 Q2		115 140	155 185	pF
C _{rss}	Reverse Transfer Capacitance	V _{DS} = -20V, V _{GS} = 0V, f = 1MHZ	Q1 Q2		75 75	115 115	pF
R _g	Gate Resistance	f = 1MHz	Q1 Q2	0.1 0.1	1.1 3.3	3.3 9.9	Ω
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time	Q1	Q1 Q2		7 7	14 14	ns
t _r	Rise Time	$V_{DD} = 20V, I_D = 9.0A, \\ V_{GS} = 10V, R_{GEN} = 6\Omega$	Q1 Q2		13 3	24 10	ns
t _{d(off)}	Turn-Off Delay Time	Q^2	Q1 Q2		17 20	31 36	ns
t _f	Fall Time	$V_{DD} = -20V, I_D = -6.5A,$ $V_{GS} = -10V, R_{GEN} = 6\Omega$	Q1 Q2		6 3	12 10	ns
Q _{g(TOT)}	Total Gate Charge	Q1	Q1 Q2		14 17	20 24	nC
Q _{gs}	Gate to Source Charge	$V_{GS} = 10V, V_{DD} = 20V, I_D = 9.0A$	Q1 Q2		2.3 3.0		nC
Q _{gd}	Gate to Drain "Miller" Charge	Q2 V _{GS} = -10V, V _{DD} = -20V, I _D = -6.5A	Q1 Q2		3.2 3.6		nC

Symbol	Parameter	Test Conditions		Туре	Min	Тур	Max	Units
Drain-So	urce Diode Characteristics							
I _S	Maximum Continuous Drain to Source Diode Forward Current		Q1 Q2			20 -20	А	
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current (Note 2)		Q1 Q2			55 -40	А	
V _{SD}	Source to Drain Diode Forward Voltage	00 / 0	Note 2) Note 2)	Q1 Q2		0.87 0.88	1.2 -1.2	V
t _{rr}	Reverse Recovery Time	Q1 I _F = 9.0A, di/dt = 100A/s		Q1 Q2		25 29	38 44	ns
Q _{rr}	Reverse Recovery Charge	Q2 I _F = -6.5A, di/dt = 100A/s	-	Q1 Q2		19 29	29 44	nC

Notes:

1. R_{0JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a. 40°C/W when mounted on a 1 in² pad of 2 oz copper

Scale 1 : 1 on letter size paper



b. 96°C/W when mounted on a minimum pad of 2 oz copper

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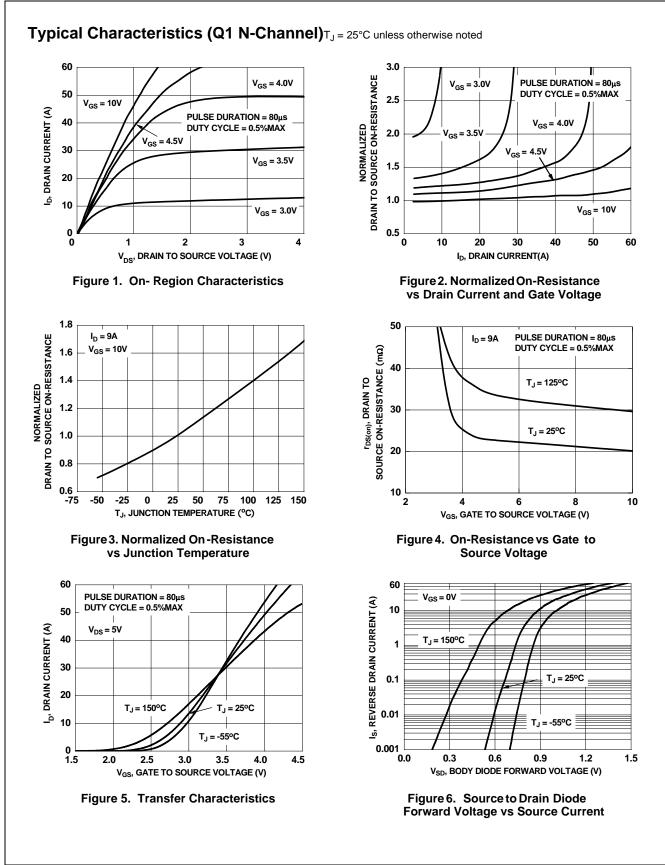


a. 40°C/W when mounted on a 1 in² pad of 2 oz copper

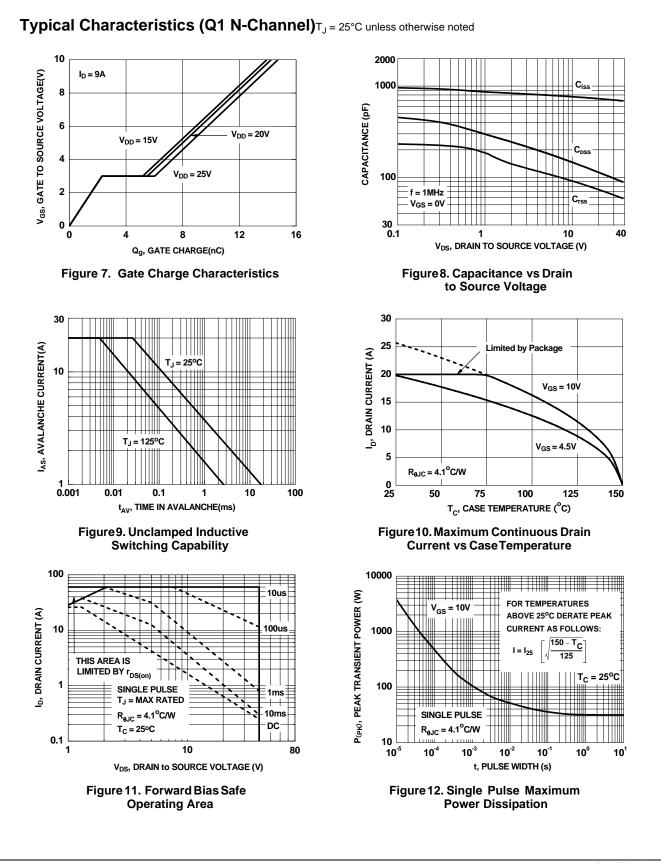
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. Starting T_J = 25°C, N-ch: L = 0.3mH, I_{AS} = 14A, V_{DD} = 40V, V_{GS} = 10V; P-ch: L = 0.3mH, I_{AS} = -15A, V_{DD} = -40V, V_{GS} = -10V.

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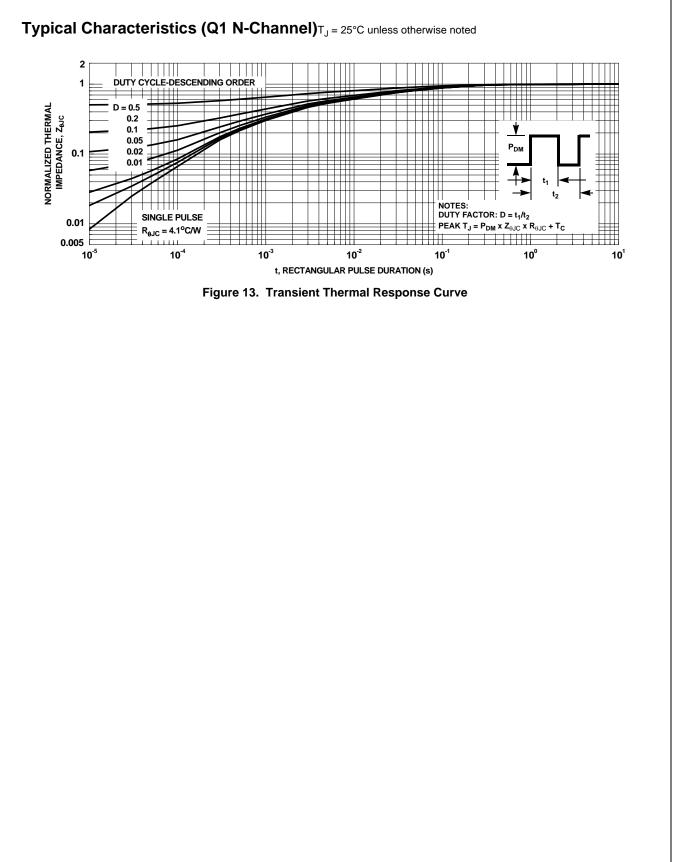


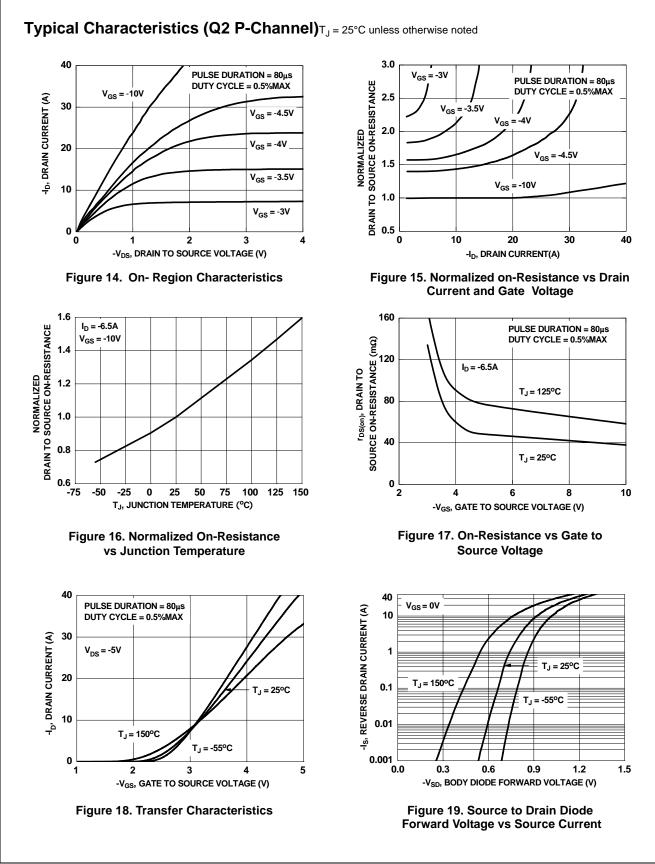
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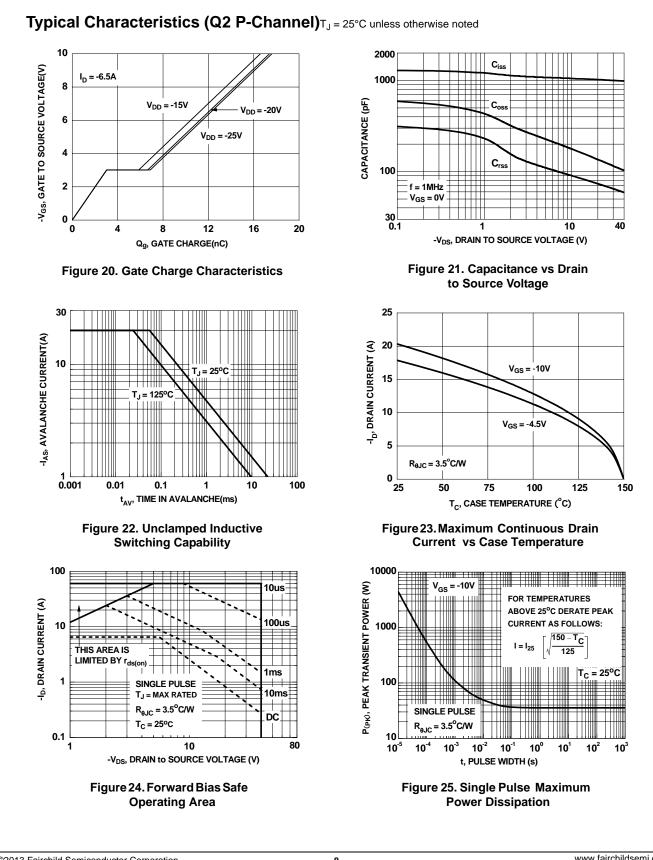
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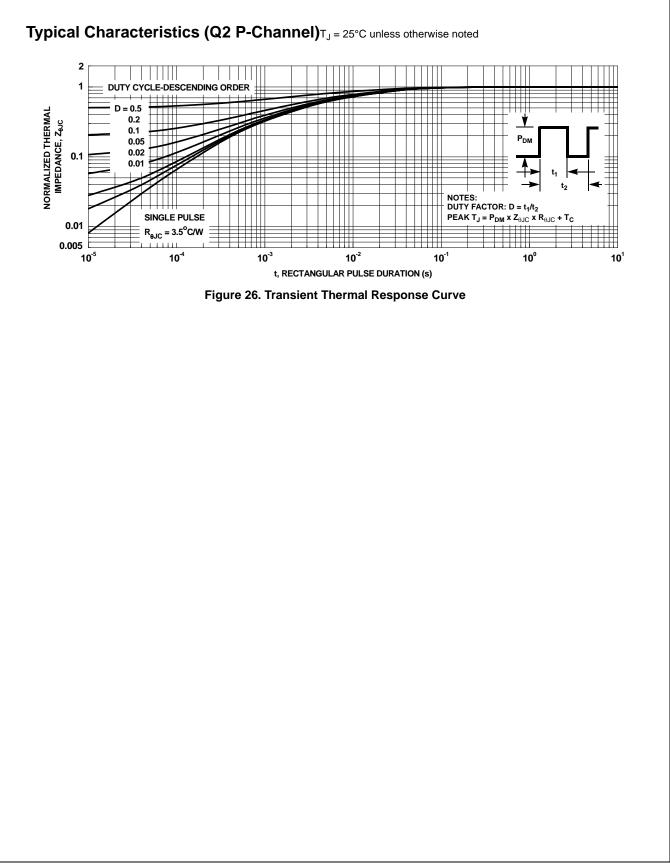
FDD8424H Dual N & P-Channel PowerTrench[®] MOSFET



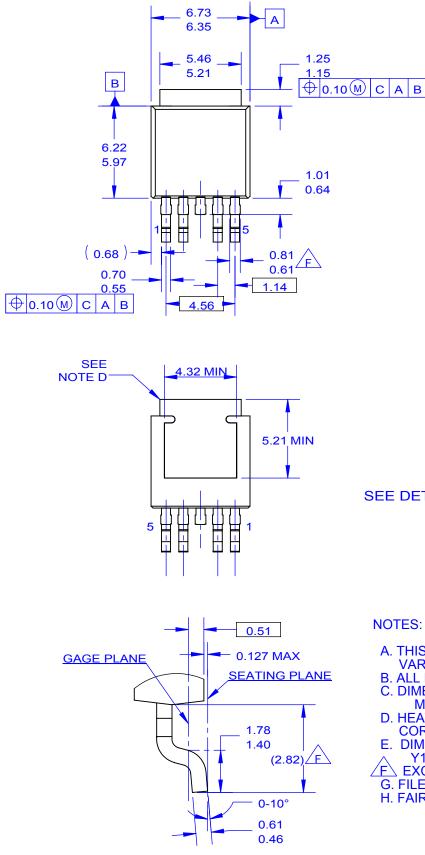




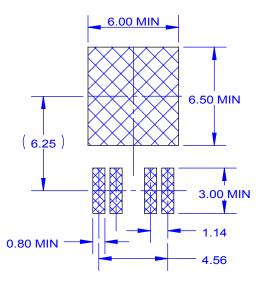


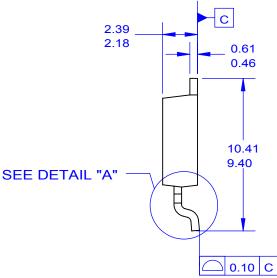


FDD8424H Dual N & P-Channel PowerTrench[®] MOSFET



DETAIL A SCALE 2:1





NOTES: UNLESS OTHERWISE SPECIFED

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